

PACKAGE/ORDERING INFORMATION

MODEL	V _{OUT} (V)	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM2202-2.5	2.5	SOT-23-5	-40°C to +85°C	SGM2202-2.5YN5G/TR	G1DXX	Tape and Reel, 3000
SGM2202-2.8	2.8	SOT-23-5	-40°C to +85°C	SGM2202-2.8YN5G/TR	SX5XX	Tape and Reel, 3000
SGM2202-3.0	3.0	SOT-23-5	-40°C to +85°C	SGM2202-3.0YN5G/TR	SX6XX	Tape and Reel, 3000
		SOT-23-5 (L-Type)	-40°C to +85°C	SGM2202-3.0YN5LG/TR	G12XX	Tape and Reel, 3000
SGM2202-3.3	3.3	SOT-23-5	-40°C to +85°C	SGM2202-3.3YN5G/TR	SX8XX	Tape and Reel, 3000
SGM2202-5.0	5.0	SOT-23-5	-40°C to +85°C	SGM2202-5.0YN5G/TR	G3DXX	Tape and Reel, 3000
SGM2202-ADJ	Adjustable	SOT-23-6	-40°C to +85°C	SGM2202-ADJYN6G/TR	SVFXX	Tape and Reel, 3000

MARKING INFORMATION

NOTE: XX = Date Code.

YYY X X

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

VIN, EN to GND -0.3V to 44V
 VOUT to GND -0.3V to Min(V_{IN} + 0.3V, 15V)
 BP, FB to GND -0.3V to Min(V_{IN} + 0.3V, 6V)
 Power Dissipation, P_D @ T_A = +25°C
 SOT-23-5, SOT-23-5 (L-Type) 0.517W
 SOT-23-6 0.558W
 Package Thermal Resistance
 SOT-23-5, SOT-23-5 (L-Type), θ_{JA} 242°C/W
 SOT-23-6, θ_{JA} 224°C/W
 Junction Temperature +150°C
 Storage Temperature Range -65°C to +150°C
 Lead Temperature (Soldering, 10s) +260°C
 ESD Susceptibility
 HBM 4000V
 MM 150V
 CDM 1000V

RECOMMENDED OPERATING CONDITIONS

Input Voltage Range 2.7V to 36V
 Operating Temperature Range -40°C to +85°C

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

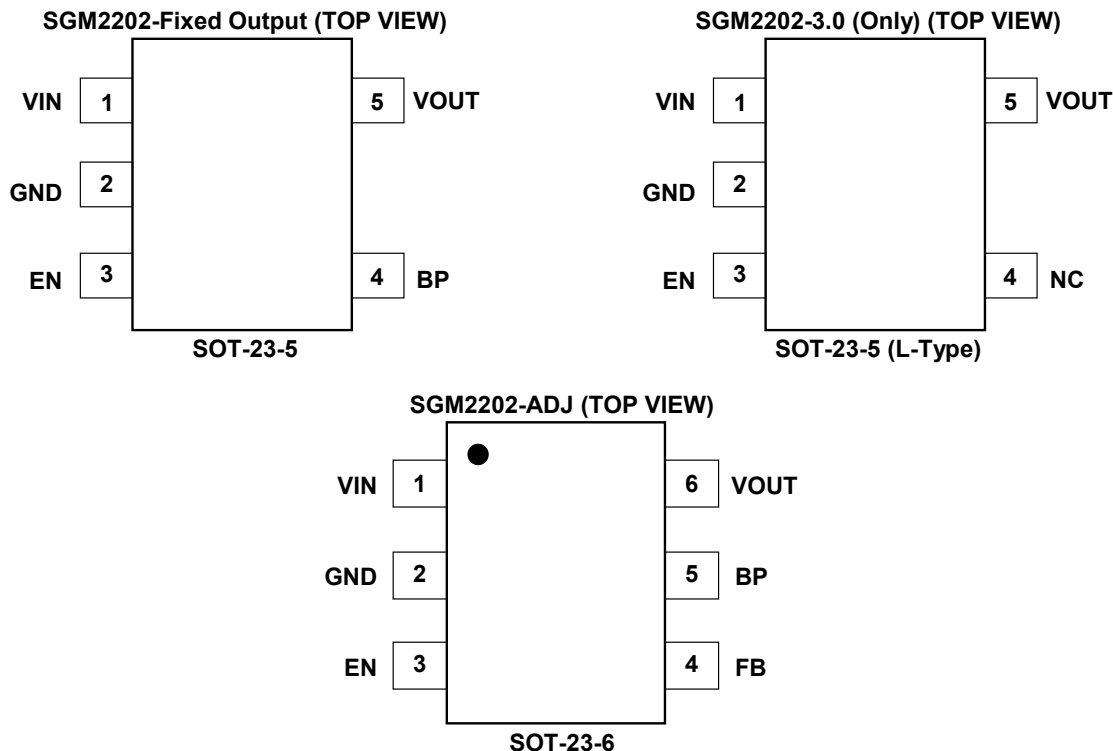
ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATIONS



PIN DESCRIPTION

PIN			NAME	FUNCTION
SOT-23-5	SOT-23-5 (L-Type)	SOT-23-6		
1	1	1	VIN	Regulator Input. Up to 36V input voltage. At least 1 μ F supply bypass capacitor is recommended.
2	2	2	GND	Ground.
3	3	3	EN	Shutdown Input. Connect to VIN pin for normal operation.
–	–	4	FB	Feedback Pin (adjustable voltage version only). This is used to set the output voltage of the device.
4	–	5	BP	Reference-Noise Bypass Pin. Bypass with a low-leakage 0.01 μ F ceramic capacitor for reduced noise at the output.
–	4	–	NC	Not Connected.
5	5	6	VOUT	Regulator Output. Recommended output capacitor range: 1 μ F to 10 μ F.

ELECTRICAL CHARACTERISTICS

($V_{IN} = 15V$, $V_{EN} = 2V$, $C_{IN} = C_{OUT} = 1\mu F$, $C_{BP} = 0.01\mu F$, Full = $-40^{\circ}C$ to $+85^{\circ}C$, typical values are at $T_A = +25^{\circ}C$, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
Input Voltage	V_{IN}	$V_{OUT} < 3.3V$	Full	2.7		32	V
		$V_{OUT} \geq 3.3V$	Full	2.7		36	
Output Voltage Accuracy		$I_{OUT} = 1mA$	$+25^{\circ}C$	-2.5		2.5	%
Feedback Voltage	V_{FB}	SGM2202-ADJ, $V_{FB} = V_{OUT}$, $I_{OUT} = 1mA$	$+25^{\circ}C$		0.8		V
FB Input Current	I_{FB}	SGM2202-ADJ, $V_{FB} = 0.9V$	Full	-15		15	nA
Ground Pin Current		No load	$+25^{\circ}C$		4.2	5.4	μA
			Full			6.5	
		$I_{OUT} = 50mA$	$+25^{\circ}C$		4.2		
Maximum Output Current ⁽¹⁾		$V_{IN} = V_{OUT} + 2V$ or 4V, whichever is greater	$+25^{\circ}C$	150			mA
Dropout Voltage ⁽²⁾	V_{DROP}	$I_{OUT} = 150mA$, $V_{OUT} \geq 2.5V$	$+25^{\circ}C$		1300	1840	mV
			Full			2380	
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \times V_{OUT}}$	$V_{IN} = V_{OUT} + 2V$ or 4V to 32V, $I_{OUT} = 1mA$, $V_{OUT} < 3.3V$	$+25^{\circ}C$		0.005	0.01	% / V
		$V_{IN} = V_{OUT} + 2V$ to 36V, $I_{OUT} = 1mA$, $V_{OUT} \geq 3.3V$	$+25^{\circ}C$		0.005	0.01	
Load Regulation	ΔV_{OUT}	$V_{IN} = V_{OUT} + 2V$ or 4V, $I_{OUT} = 1mA$ to 150mA	$+25^{\circ}C$		10	24	mV
Power Supply Rejection Ratio	PSRR	$V_{OUT} = 3.3V$, $I_{OUT} = 10mA$	$f = 217Hz$, $+25^{\circ}C$		55		dB
			$f = 1kHz$, $+25^{\circ}C$		40		
Output Voltage Temperature Coefficient ⁽³⁾	$\frac{\Delta V_{OUT}}{\Delta T_A \times V_{OUT}}$	$V_{IN} = V_{OUT} + 2V$ or 4V, $I_{OUT} = 1mA$	Full		35		ppm/ $^{\circ}C$
Shutdown							
EN Input Threshold	V_{IH}	$V_{IN} = 2.7V$ to 36V	Full	1.2			V
	V_{IL}		Full			0.4	
EN Input Bias Current	I_{BH}	$V_{EN} = V_{IN}$	Full		0.02	1	μA
	I_{BL}	$V_{EN} = 0V$	Full	-1		1	
Shutdown Supply Current	$I_{Q(SHDN)}$	$V_{EN} = 0V$	$+25^{\circ}C$		1.5	2	μA
Start-Up Time ⁽⁴⁾	t_{STR}	No load	$+25^{\circ}C$		5		ms
R_{ON} of Discharge MOSFET		$V_{IN} = 2.7V$, $V_{EN} = 0V$, $I_{OUT} = -1mA$	$+25^{\circ}C$		75		Ω
Thermal Protection							
Thermal Shutdown Temperature	T_{SHDN}				150		$^{\circ}C$
Thermal Shutdown Hysteresis	ΔT_{SHDN}				20		$^{\circ}C$

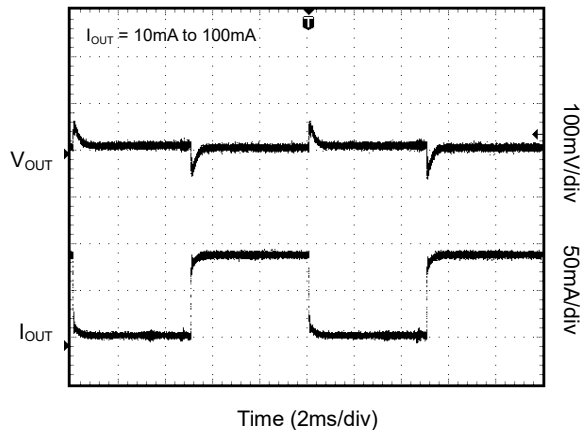
NOTES:

- Maximum output current is affected by the PCB layout, size of metal trace, the thermal conduction path between metal layers, ambient temperature and the other environment factors of system. Attention should be paid to the dropout voltage when $V_{IN} < V_{OUT} + V_{DROP}$.
- The dropout voltage is defined as $V_{IN} - V_{OUT}$, when V_{OUT} is 95% of the value of V_{OUT} for $V_{IN} = V_{OUT} + 2V$.
- Output voltage temperature coefficient is defined as the worst-case voltage change divided by the total temperature range.
- Time needed for V_{OUT} to reach 90% of final value.

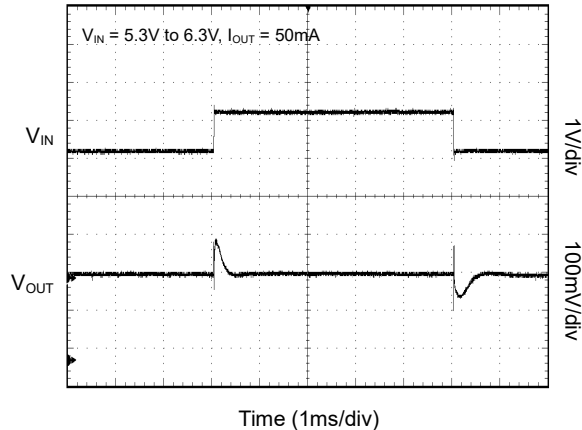
TYPICAL PERFORMANCE CHARACTERISTICS

$T_A = +25^\circ\text{C}$, $V_{IN} = 5.3\text{V}$, $V_{EN} = 2\text{V}$, $V_{OUT} = 3.3\text{V}$, $C_{IN} = C_{OUT} = 1\mu\text{F}$, $C_{BP} = 0.01\mu\text{F}$, unless otherwise noted.

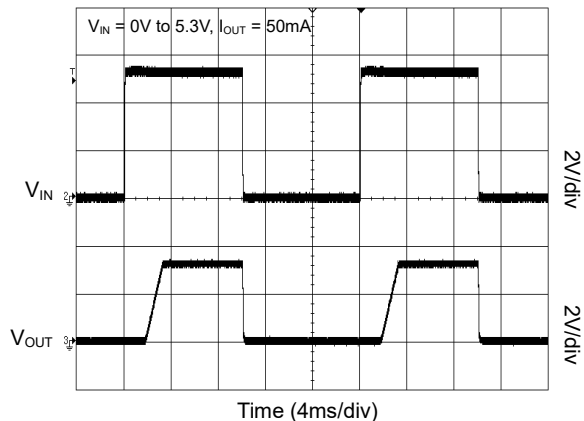
Load-Transient Response



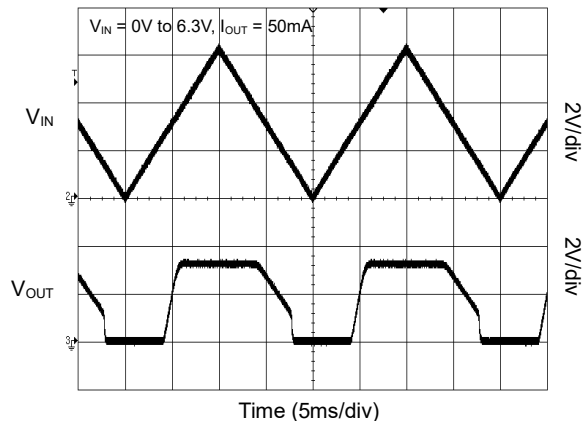
Line-Transient Response



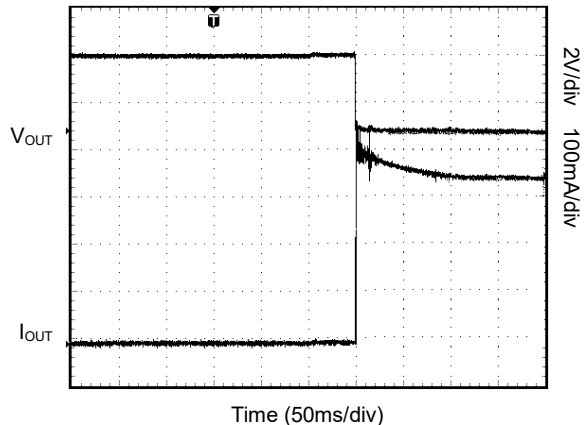
Power-Up/Power-Down Output Waveform



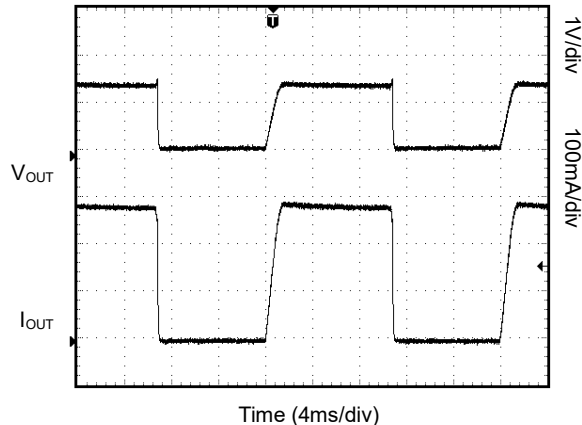
Power Ramp-Up/Ramp-Down Output Waveform



Output Short Waveform



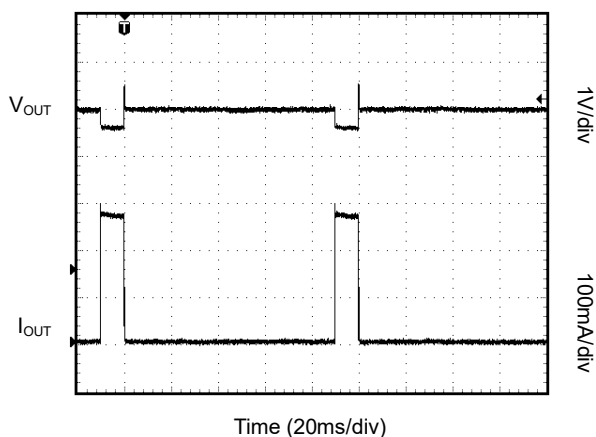
Thermal Protection Waveform



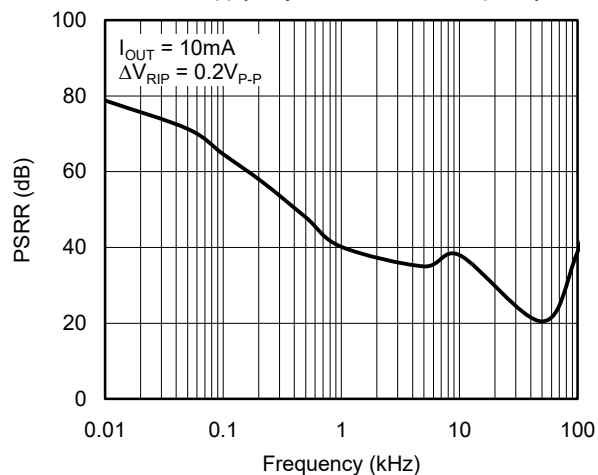
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

$T_A = +25^\circ\text{C}$, $V_{IN} = 5.3\text{V}$, $V_{EN} = 2\text{V}$, $V_{OUT} = 3.3\text{V}$, $C_{IN} = C_{OUT} = 1\mu\text{F}$, $C_{BP} = 0.01\mu\text{F}$, unless otherwise noted.

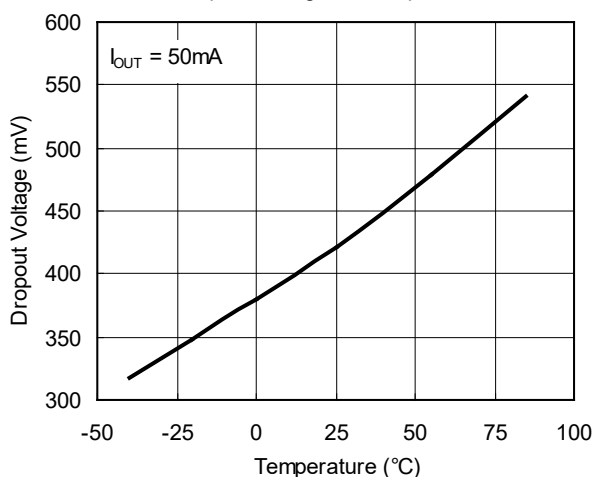
Pulse Load Current Output Waveform



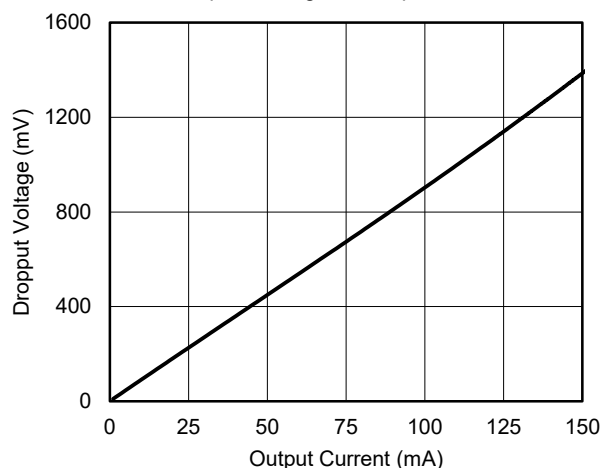
Power Supply Rejection Ratio vs. Frequency



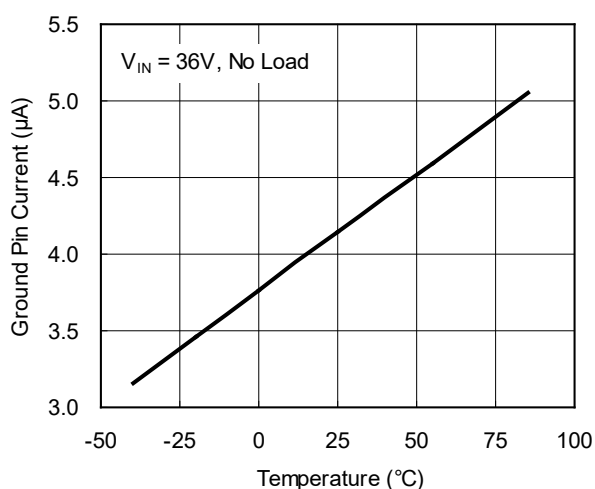
Dropout Voltage vs. Temperature



Dropout Voltage vs. Output Current



Ground Pin Current vs. Temperature



DETAILED DESCRIPTION

The SGM2202 series is a linear regulator designed primarily for high input voltage applications. The SGM2202 series is available in several fixed output voltages and adjustable from 0.8V to 13.2V with a simple resistor divider. The maximum output current is dependent on the package's maximum power dissipation for a given temperature.

CMOS technology ensures low dropout voltage and low quiescent current.

The SGM2202 adjustable voltage version uses external feedback, allowing the user to set the output voltage with an external resistor divider. The typical FB pin voltage is 0.8V.

The IC enters shutdown mode when EN is low. In shutdown mode, the pass transistor and control circuitry are turned off, reducing the supply current to < 2μA. Connect EN to VIN for automatic startup.

APPLICATION INFORMATION

Setting the Output Voltage

Set the output voltage of the SGM2202 adjustable voltage version by using a resistor divider as shown:

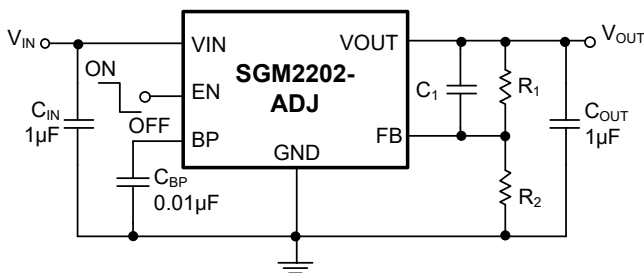


Figure 3. SGM2202-ADJ with External Resistor Divider

Choose $R_2 = 2\text{M}\Omega$ to maintain a 0.4μA minimum load. Calculate the value for R_1 using the following equation:

$$R_1 = R_2 \times \left(\frac{V_{\text{OUT}}}{0.8\text{V}} - 1 \right)$$

Input Capacitor and Output Capacitor

For proper operation, place a ceramic capacitor (C_{IN}) between 1μF and 10μF between the input pin and ground. Larger values in this range will help improve line transient response.

For stable operation, use a ceramic capacitor (C_{OUT}) between 1μF and 10μF. Larger values in this range will help improve load transient response and reduce noise. Output capacitors of other dielectric types may be used, but are not recommended as their capacitance can deviate greatly from their rated value over temperature.

Thermal Considerations

When the junction temperature is too high, the thermal protection circuitry sends a signal to the control logic that will shutdown the IC. The IC will restart when the temperature has sufficiently cooled down.

The maximum power dissipation is dependent on the thermal resistance of the case and the circuit board, the temperature difference between the die junction and the ambient air, and the rate of air flow.

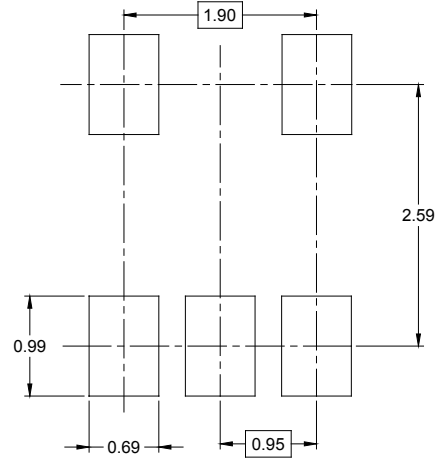
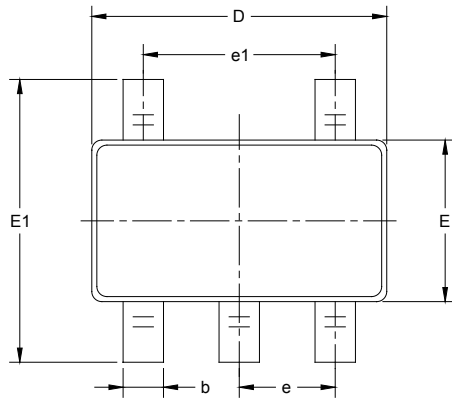
REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

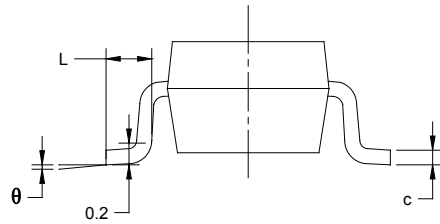
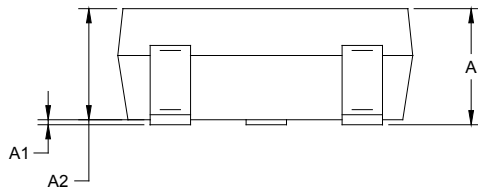
OCTOBER 2020 – REV.A.1 to REV.A.2	Page
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Changes from Original (APRIL 2017) to REV.A	Page
Changed from product preview to production data.....	All

PACKAGE OUTLINE DIMENSIONS

SOT-23-5



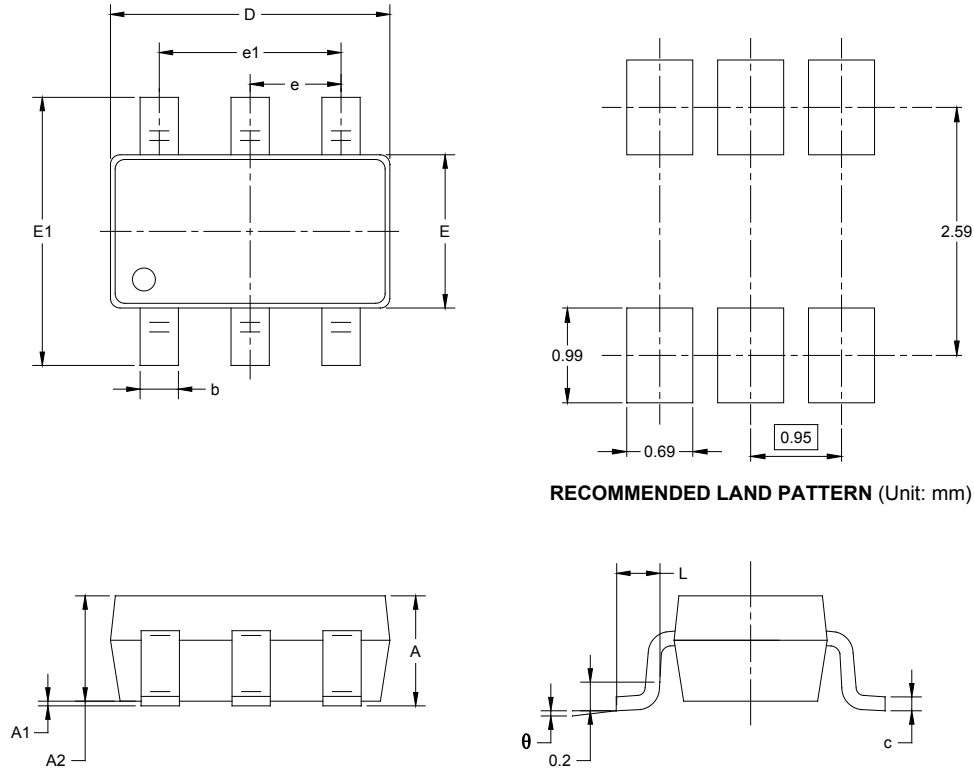
RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 BSC		0.037 BSC	
e1	1.900 BSC		0.075 BSC	
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

SOT-23-6

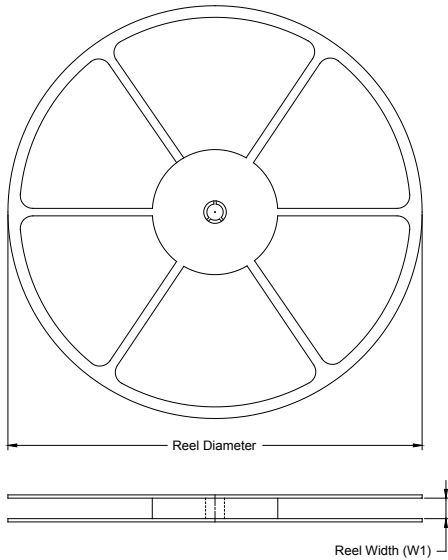


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 BSC		0.037 BSC	
e1	1.900 BSC		0.075 BSC	
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

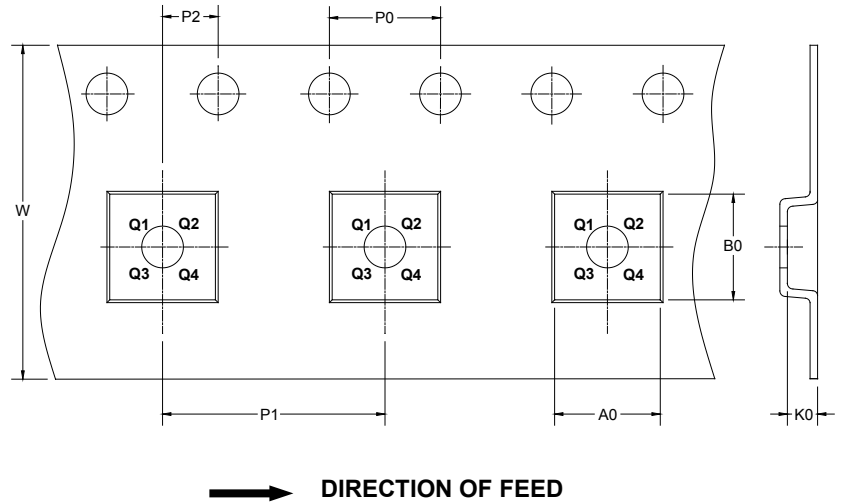
PACKAGE INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

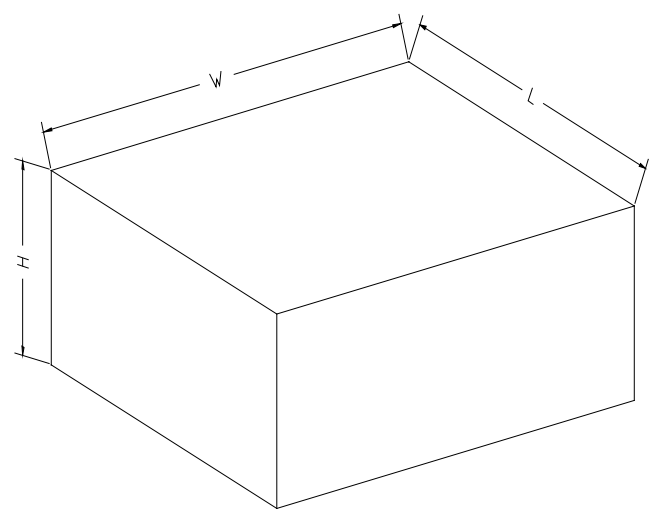
KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT-23-5	7"	9.5	3.20	3.20	1.40	4.0	4.0	2.0	8.0	Q3
SOT-23-6	7"	9.5	3.17	3.23	1.37	4.0	4.0	2.0	8.0	Q3

DD0001

PACKAGE INFORMATION

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18

DD0002